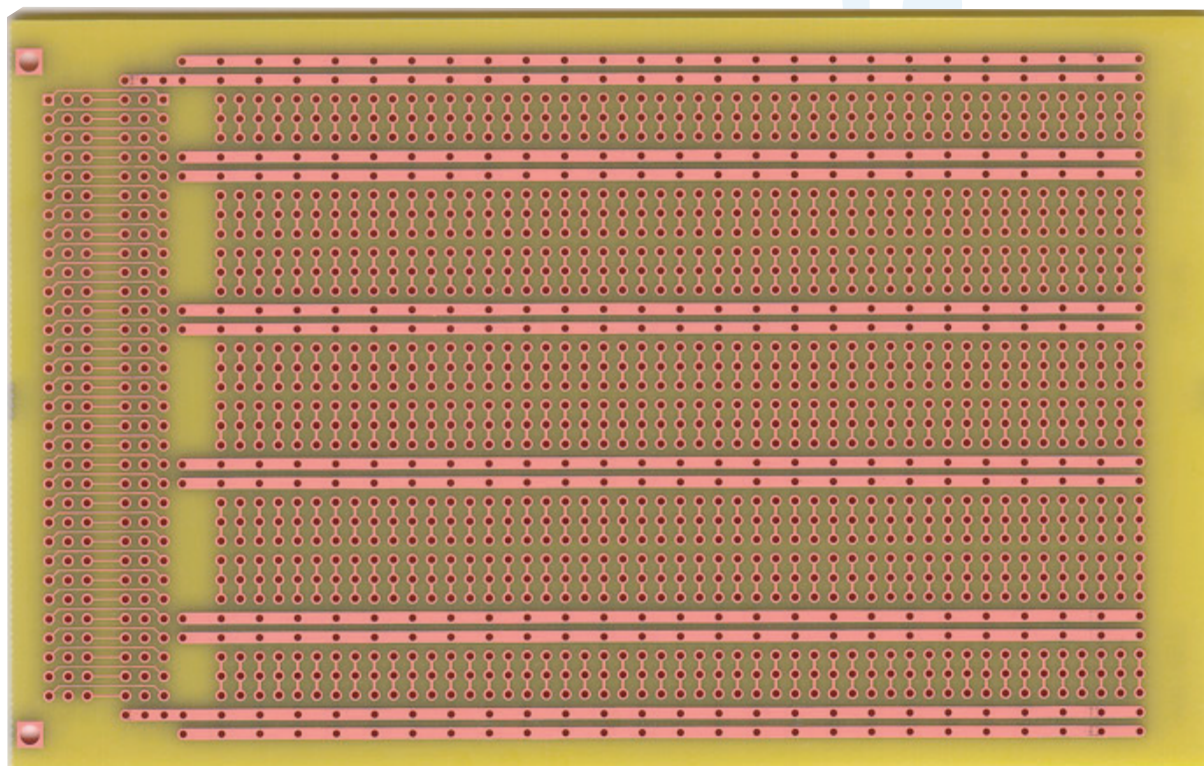


Prototyping board KU-3

size 1:1



21259

- Epoxy fibre-glass FR4 thickness 1,6 mm
- Copper thickness 35 μ m double-sided
- OSP Organic Solderability Preservative
- Hole diameter 1,0 mm
- Size 100 x 160 mm
- Connector 32/64/96 pin DIN41612 C
- Hole spacing 2,54 x 2,54 mm (1,0 x 1,0 inch)
- Plated through holes
- General hole mounted electronics & DIL packages